HIKSEMI HS-Udimm-FUTURE

UDIMM memory module with heatsink for desktops (FUTURE series)
· Specification summary



Type	Udimm
Capacity	8 GB | 16 GB | 32 GB | 8 GB × 2 | 16 GB × 2 | 32 GB × 2
Interface	DDR4/DDR5
Frequency	3200 / 3600 / 4000 / 6000 / 6400 / 6800 / 7200 / 7600 / 8000 MHz
Pin	288pin
Size (L×W×H mm)	133.25 × 31.25 × 1.4 / 133.25 × 31.25 × 3.77
Operating temperature	0 °C to 85 °C (32 °F to 185 °F)
Weight	70 g / 70 g × 2
Appearance	Heatsink
Applications	Consumer
Part numbers (supplier list)	HSC408U32C2 (FUTURE U10 DDR4 3200 MHz 8 GB); HSC416U32C2 (DDR4 3200 MHz 16 GB); HSC516U48C2 (DDR5 4800 MHz 16 GB); HSC516U56C2 (DDR5 5600 MHz 16 GB); HSC516U60C2 (DDR5 6000 MHz 16 GB); HSC516U64C2 (DDR5 6400 MHz, capacity to confirm)

Specifications are summarised from the manufacturer's published information (checked 2026-11-02). They describe the cited version only. Confirm the exact model, suffix and supplied revision before ordering. ISD confirms supply, price, availability and warranty separately.

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